FAIRCHILD

SEMICONDUCTOR™

September 1983
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MM74HC00
Quad 2-Input NAND Gate

General Description

The MM74HC00 NAND gates utilize advanced silicon-gate CMOS technology to achieve operating speeds similar to LS-TTL gates with the low power consumption of standard CMOS integrated circuits. All gates have buffered outputs. All devices have high noise immunity and the ability to drive 10 LS-TTL loads. The 74HC logic family is functionally as well as pin-out compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.
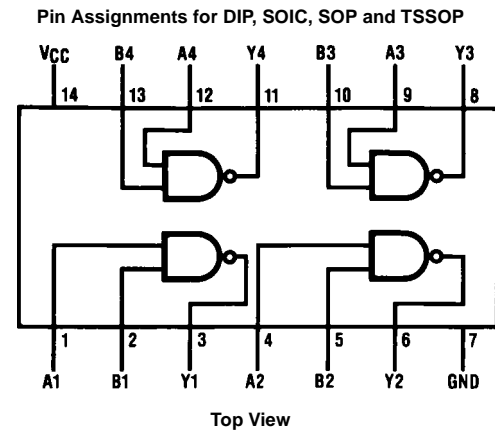
Features

■ Typical propagation delay: 8 ns
■ Wide power supply range: 2–6V
■ Low quiescent current: 20 μA maximum (74HC Series)
■ Low input current: 1 μA maximum
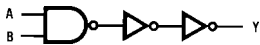■ Fanout of 10 LS-TTL loads

Ordering Code:

Order Number	Package Number	Package Description
MM74HC00M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow
MM74HC00SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HC00MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HC00N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram

Pin Assignments for DIP, SOIC, SOP and TSSOP

Top View

Logic Diagram

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Absolute Maximum Ratings(Note 1)

(Note 2)

Supply Voltage (V_{CC})	−0.5 to +7.0V
DC Input Voltage (V_{IN})	−1.5 to V_{CC}+1.5V
DC Output Voltage (V_{OUT})	−0.5 to V_{CC}+0.5V
Clamp Diode Current (I_{IK}, I_{OK})	±20 mA
DC Output Current, per pin (I_{OUT})	±25 mA
DC V_{CC} or GND Current, per pin (I_{CC})	±50 mA
Storage Temperature Range (T_{STG})	−65°C to +150°C
Power Dissipation (P_D)	
(Note 3)	600 mW
S.O. Package only	500 mW
Lead Temperature (T_L)	
(Soldering 10 seconds)	260°C

Recommended Operating Conditions

	Min	Max	Units
Supply Voltage (V_{CC})	2	6	V
DC Input or Output Voltage	0	V_{CC}	V
(V_{IN}, V_{OUT})			
Operating Temperature Range (T_A)	−40	+85	°C
Input Rise or Fall Times			
(t_r, t_f) V_{CC} = 2V		1000	ns
V_{CC} = 4.5V		500	ns
V_{CC} = 6.0V		400	ns

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: −12 mW/°C from 65°C to 85°C.

DC Electrical Characteristics (Note 4)

Symbol	Parameter	Conditions	V_{CC}	T_A = 25°C	T_A = −40 to 85°C	T_A = −55 to 125°C	Units
				Typ	Guaranteed Limits		
V_{IH}	Minimum HIGH Level		2.0V		1.5	1.5	1.5	V
	Input Voltage		4.5V		3.15	3.15	3.15	V
			6.0V		4.2	4.2	4.2	V
V_{IL}	Maximum LOW Level		2.0V		0.5	0.5	0.5	V
	Input Voltage		4.5V		1.35	1.35	1.35	V
			6.0V		1.8	1.8	1.8	V
V_{OH}	Minimum HIGH Level	V_{IN} = V_{IH} or V_{IL}					
	Output Voltage	$|I_{OUT}| \leq 20$ µA	2.0V	2.0	1.9	1.9	1.9	V
			4.5V	4.5	4.4	4.4	4.4	V
			6.0V	6.0	5.9	5.9	5.9	V
		V_{IN} = V_{IH} or V_{IL}					
		$|I_{OUT}| \leq 4.0$ mA	4.5V	4.2	3.98	3.84	3.7	V
		$|I_{OUT}| \leq 5.2$ mA	6.0V	5.7	5.48	5.34	5.2	V
V_{OL}	Maximum LOW Level	V_{IN} = V_{IH}					
	Output Voltage	$|I_{OUT}| \leq 20$ µA	2.0V	0	0.1	0.1	0.1	V
			4.5V	0	0.1	0.1	0.1	V
			6.0V	0	0.1	0.1	0.1	V
		V_{IN} = V_{IH}					
		$|I_{OUT}| \leq 4.0$ mA	4.5V	0.2	0.26	0.33	0.4	V
		$|I_{OUT}| \leq 5.2$ mA	6.0V	0.2	0.26	0.33	0.4	V
I_{IN}	Maximum Input Current	V_{IN} = V_{CC} or GND	6.0V		±0.1	±1.0	±1.0	µA
I_{CC}	Maximum Quiescent Supply Current	V_{IN} = V_{CC} or GND I_{OUT} = 0 µA	6.0V		2.0	20	40	µA

Note 4: For a power supply of 5V ±10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5V and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

AC Electrical Characteristics

$V_{CC} = 5V$, $T_A = 25°C$, $C_L = 15$ pF, $t_r = t_f = 6$ ns

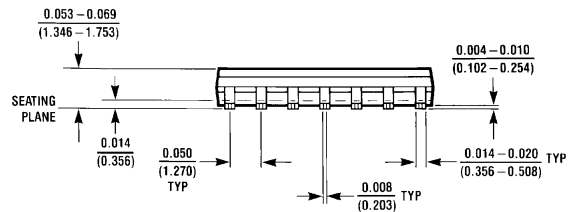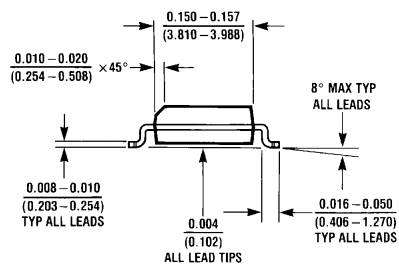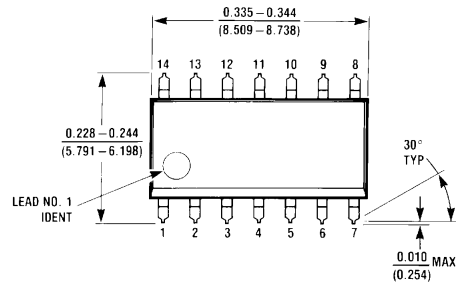| Symbol	Parameter	Conditions	Typ	Guaranteed Limit	Units
t_{PHL}, t_{PLH}	Maximum Propagation Delay		8	15	ns

AC Electrical Characteristics

$V_{CC} = 2.0V$ to $6.0V$, $C_L = 50$ pF, $t_r = t_f = 6$ ns (unless otherwise specified)

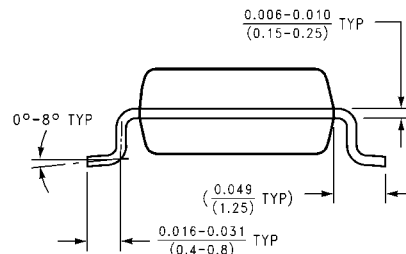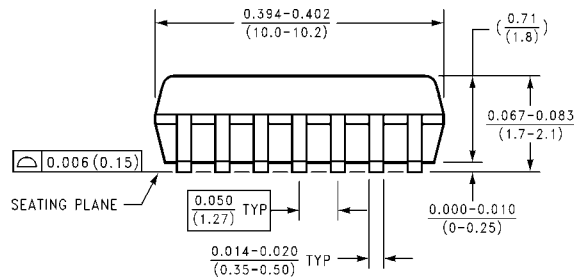| Symbol	Parameter	Conditions	V_{CC}	$T_A = 25°C$	$T_A = -40$ to $85°C$	$T_A = -55$ to $125°C$	Units
				Typ	Guaranteed Limits		
t_{PHL}, t_{PLH}	Maximum Propagation Delay		2.0V	45	90	113	134	ns
			4.5V	9	18	23	27	ns
			6.0V	8	15	19	23	ns
t_{TLH}, t_{THL}	Maximum Output Rise and Fall Time		2.0V	30	75	95	110	ns
			4.5V	8	15	19	22	ns
			6.0V	7	13	16	19	ns
C_{PD}	Power Dissipation Capacitance (Note 5)	(per gate)		20				pF
C_{IN}	Maximum Input Capacitance			5	10	10	10	pF

Note 5: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

MM74HC00

Physical Dimensions inches (millimeters) unless otherwise noted

$$\frac{0.335-0.344}{(8.509-8.738)}$$

$$\frac{0.228-0.244}{(5.791-6.198)}$$

LEAD NO. 1
IDENT

30°
TYP

$$\frac{0.010}{(0.254)} MAX$$

$$\frac{0.150-0.157}{(3.810-3.988)}$$

$$\frac{0.010-0.020}{(0.254-0.508)} \times 45°$$

8° MAX TYP
ALL LEADS

$$\frac{0.008-0.010}{(0.203-0.254)}$$ TYP ALL LEADS

$$\frac{0.004}{(0.102)}$$ ALL LEAD TIPS

$$\frac{0.016-0.050}{(0.406-1.270)}$$ TYP ALL LEADS

$$\frac{0.053-0.069}{(1.346-1.753)}$$

$$\frac{0.004-0.010}{(0.102-0.254)}$$

SEATING PLANE

$$\frac{0.014}{(0.356)}$$

$$\frac{0.050}{(1.270)} TYP$$

$$\frac{0.008}{(0.203)} TYP$$

$$\frac{0.014-0.020}{(0.356-0.508)} TYP$$

M14A (REV H)

14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-120, 0.150" Narrow
Package Number M14A

$$\frac{0.295-0.319}{(7.5-8.1)}$$

$$\frac{0.205-0.213}{(5.2-5.4)}$$

$$\frac{0.394-0.402}{(10.0-10.2)}$$

$$\left(\frac{0.71}{(1.8)}\right)$$

$$\frac{0.067-0.083}{(1.7-2.1)}$$

$$\frac{0.006-0.010}{(0.15-0.25)} TYP$$

$$\boxed{\triangle} 0.006 (0.15)$$

SEATING PLANE

$$\frac{0.050}{(1.27)} TYP$$

$$\frac{0.000-0.010}{(0-0.25)}$$

$$\frac{0.014-0.020}{(0.35-0.50)} TYP$$

0°-8° TYP

$$\left(\frac{0.049}{(1.25)} TYP\right)$$

$$\frac{0.016-0.031}{(0.4-0.8)} TYP$$
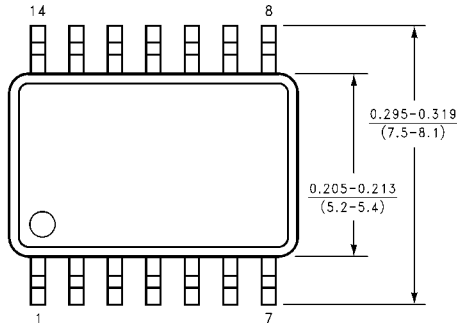
M14D (REV B)

14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M14D

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)
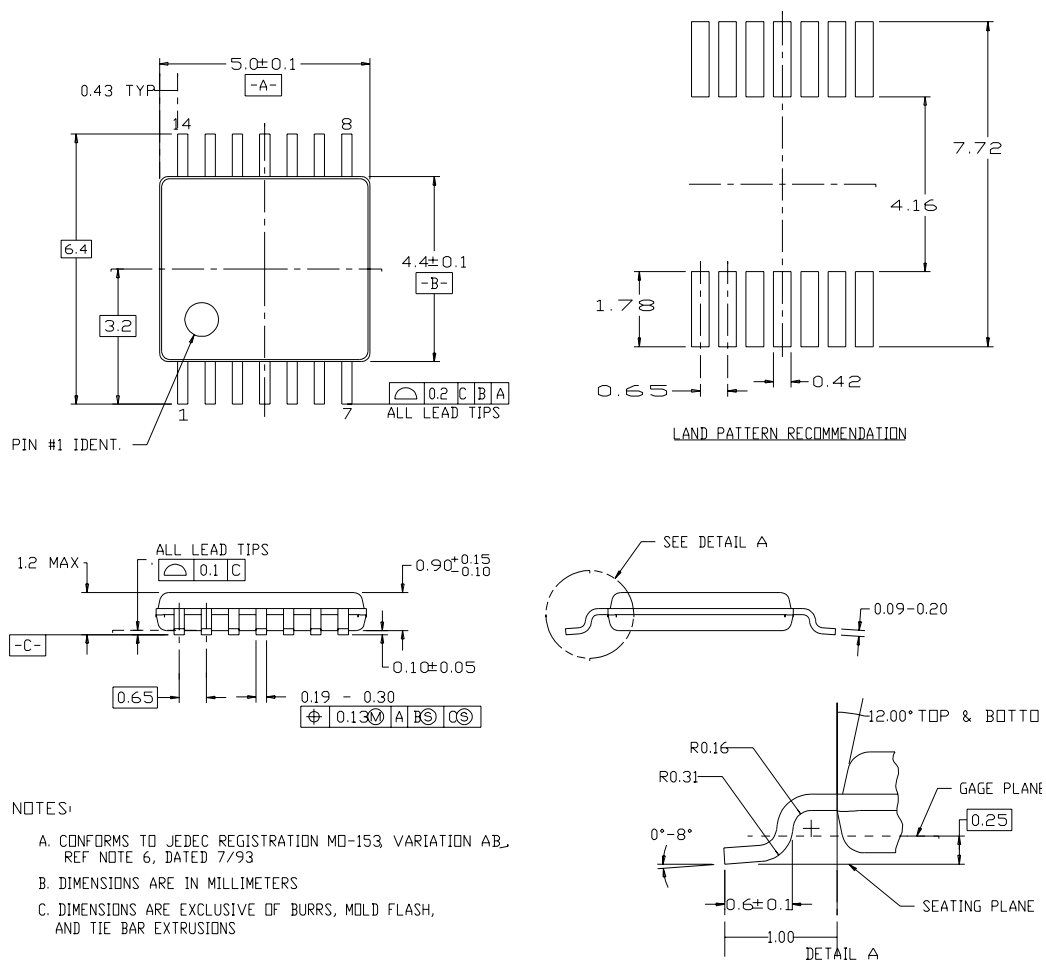
14LD, TSSOP, JEDEC MO-153, 4.4MM WIDE

5.0±0.1
-A-

0.43 TYP

14   8

6.4

3.2

4.4±0.1
-B-

⌀ 0.2 C B A
ALL LEAD TIPS

1   7

PIN #1 IDENT.

7.72

4.16

1.78

0.65   0.42

LAND PATTERN RECOMMENDATION

1.2 MAX

ALL LEAD TIPS
⌀ 0.1 C

-C-

0.90 +0.15 −0.10

0.10±0.05

0.65   0.19 − 0.30

⊕ 0.13 Ⓜ A BⓈ CⓈ

SEE DETAIL A

0.09−0.20

12.00° TOP & BOTTO

R0.16

R0.31

GAGE PLANE

0.25

0°-8°

0.6±0.1

1.00

DETAIL A

SEATING PLANE

NOTES:

A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB,
   REF NOTE 6, DATED 7/93

B. DIMENSIONS ARE IN MILLIMETERS

C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH,
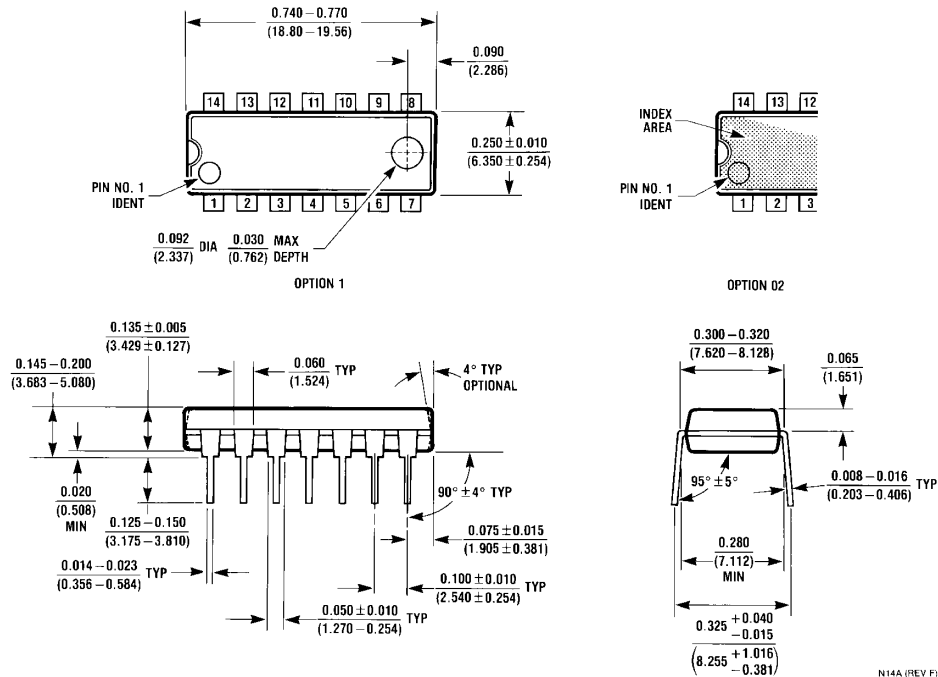   AND TIE BAR EXTRUSIONS

14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
Package Number MTC14

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

0.740 − 0.770
(18.80 − 19.56)

0.090
(2.286)

14 13 12 11 10 9 8

0.250 ± 0.010
(6.350 ± 0.254)

PIN NO. 1
IDENT

1 2 3 4 5 6 7

$\frac{0.092}{(2.337)}$ DIA $\frac{0.030}{(0.762)}$ MAX DEPTH

OPTION 1

INDEX AREA

14 13 12

PIN NO. 1
IDENT

1 2 3

OPTION 02

0.135 ± 0.005
(3.429 ± 0.127)

0.145 − 0.200
(3.683 − 5.080)

0.060
(1.524) TYP

4° TYP
OPTIONAL

0.020
(0.508)
MIN

0.125 − 0.150
(3.175 − 3.810)

90° ± 4° TYP

0.075 ± 0.015
(1.905 ± 0.381)

0.014 − 0.023
(0.356 − 0.584) TYP

0.100 ± 0.010
(2.540 ± 0.254) TYP

0.050 ± 0.010
(1.270 − 0.254) TYP

0.300 − 0.320
(7.620 − 8.128)

0.065
(1.651)

95° ± 5°

0.008 − 0.016
(0.203 − 0.406) TYP

0.280
(7.112)
MIN

$0.325 \begin{smallmatrix} +0.040 \\ -0.015 \end{smallmatrix}$

$\left(8.255 \begin{smallmatrix} +1.016 \\ -0.381 \end{smallmatrix}\right)$

N14A (REV F)

14-Lead Plastic Dual-In Line Package (PDIP), JEDEC MS-001, 0.300" Wide
Package Number N14A

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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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